

Application Data Sheet

Application Information

Application Type::	Regular
Subject Matter::	Utility
Title::	Finger Metal-Insulator-Metal Capacitor Device with Local Interconnect
Attorney Docket Number::	MXIC 1518-2
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	1
Total Drawing Sheets::	4
Small Entity?::	No

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	R.O.C.
Status::	Full Capacity
Given Name::	Lennis
Family Name::	Liu
City of Residence::	Hsinchu
State or Province of Residence::	Taiwan
Country of Residence::	R.O.C.
Street of mailing address::	No. 3, Alley 12, Lane 520, Shiuefu Rd., Judung Jen
City of mailing address::	Hsinchu
State or Province of mailing address::	Taiwan
Country of mailing address::	R.O.C.
Postal or Zip Code of mailing address::	310

Applicant Authority Type:: Inventor
Primary Citizenship Country:: R.O.C.
Status:: Full Capacity
Given Name:: Chong Jen
Family Name:: Hwang
City of Residence:: Hsinchu
State or Province of Residence:: Taiwan
Country of Residence:: R.O.C.
Street of mailing address:: 2F, No. 9, Park Ave. 1
Science-Based Industrial Park
City of mailing address:: Taipei
State or Province of mailing address:: Taiwan
Country of mailing address:: R.O.C.

Correspondence Information

Correspondence Customer Number:: 22470

Representative Information

Representative Customer Number::	22470	
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Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This application	Division of	10/077,450	02/15/2002

Assignee Information

Assignee name::	Macronix International Co., Ltd.
Street of mailing address::	No. 16, Li-Hsin Road Science-Based Industrial Park
City of mailing address::	Hsinchu
State or Province of mailing address::	Taiwan
Country of mailing address::	R.O.C.
Postal or Zip Code of mailing address::	300